



**flow90PIM 1**

**1200 V / 25 A**

**Topology features**

- Converter+Inverter
- Open Emitter configuration
- Temperature sensor

**Component features**

- Easy paralleling
- Low turn-off losses
- Low collector emitter saturation voltage
- Positive temperature coefficient
- Short tail current
- Switching optimized for EMC

**Housing features**

- Base isolation: Al<sub>2</sub>O<sub>3</sub>
- 90° mounting angle between heatsink and PCB
- Screw-on heatsink mounting
- Clip-in PCB mounting
- Thermo-mechanical push-and-pull force relief
- Solder pin

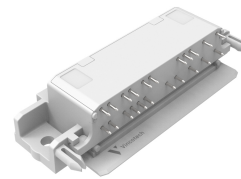
**Target applications**

- Embedded Drives
- HVAC
- Industrial Drives

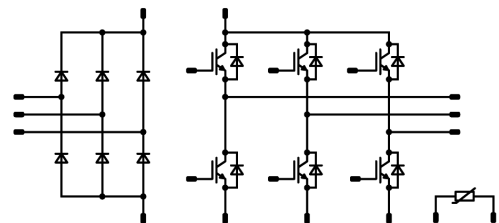
**Types**

- 10-R112PNA025M7-P630C70

**flow90 1 housing**



**Schematic**





Vincotech

**10-R112PNA025M7-P630C70**  
datasheet

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Inverter Switch</b>				
Collector-emitter voltage	$V_{CES}$		1200	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	34	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	50	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	82	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15\text{ V}$ , $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	9,5	$\mu\text{s}$
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$
<b>Inverter Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	33	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	50	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	62	W
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$
<b>Rectifier Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1600	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	38	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	200	A
Surge current capability	$I^2t$		200	$\text{A}^2\text{s}$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	47	W
Maximum junction temperature	$T_{jmax}$		150	$^{\circ}\text{C}$



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**10-R112PNA025M7-P630C70**  
datasheet

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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### Module Properties

#### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	°C

#### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	$V_{isol}$	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			11,67	mm
Comparative Tracking Index	CTI		$\geq 200$	

\*100 % tested in production



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### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

#### Inverter Switch

##### Static

Gate-emitter threshold voltage	$V_{GE(th)}$			10	0,0025	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		25	25 125 150		1,64 1,89 1,95	2,1 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			70	μA
Gate-emitter leakage current	$I_{GES}$		0	0		25			200	nA
Internal gate resistance	$r_g$							None		Ω
Input capacitance	$C_{ies}$							4800		pF
Output capacitance	$C_{oes}$		0	10		25		170		pF
Reverse transfer capacitance	$C_{res}$							57		pF
Gate charge	$Q_g$	$V_{CC} = 600$ V	0/15		25	25		180		nC

##### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,16		K/W
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##### Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		77,6 77,8 77,4		ns
Rise time	$t_r$					25 125 150		10,4 12,8 13,8		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		145,4 165 170,4		ns
Fall time	$t_f$					25 125 150		97,98 107,95 111,97		ns
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD} = 2,64$ μC $Q_{tFWD} = 3,89$ μC $Q_{tFWD} = 4,28$ μC				25 125 150		1,47 1,95 2,06		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		1,65 2,14 2,26		mWs



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10-R112PNA025M7-P630C70  
datasheet

### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		
<b>Inverter Diode</b>										
<b>Static</b>										
Forward voltage	$V_F$				25	25 125 150		1,63 1,7 1,69	2,1 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1200$ V				25			35	μA
<b>Thermal</b>										
Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,54		K/W
<b>Dynamic</b>										
Peak recovery current	$I_{RM}$					25 125 150		29,3 29,99 30,55		A
Reverse recovery time	$t_{rr}$					25 125 150		218,33 323,9 357,05		ns
Recovered charge	$Q_r$	$di/dt=2064$ A/μs $di/dt=1374$ A/μs $di/dt=1391$ A/μs	±15	600	25	25 125 150		2,64 3,89 4,28		μC
Reverse recovered energy	$E_{rec}$					25 125 150		0,971 1,51 1,68		mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					25 125 150		490,19 298,63 281,65		A/μs



### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

#### Rectifier Diode

##### Static

Forward voltage	$V_F$				8	25 125		0,96 0,865	1,21 <sup>(1)</sup> 1,1 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_i = 1600$ V				25			50	μA

##### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,49		K/W
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#### Thermistor

##### Static

Rated resistance	$R$					25		22		kΩ
Deviation of R100	$\Delta_{R/R}$	$R_{100} = 1484$ Ω				100	-5		5	%
Power dissipation	$P$					25		130		mW
Power dissipation constant	$d$					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.

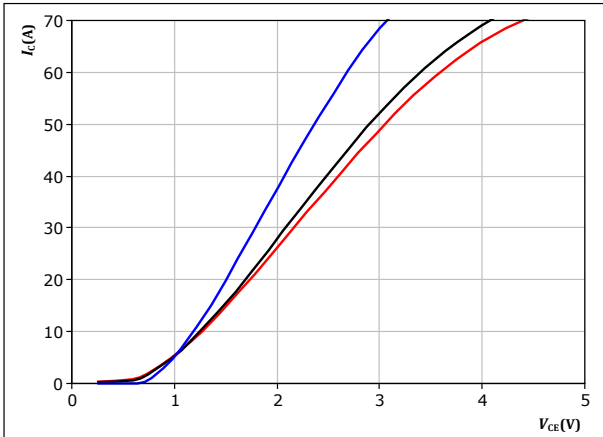


## Inverter Switch Characteristics

**figure 1.** IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



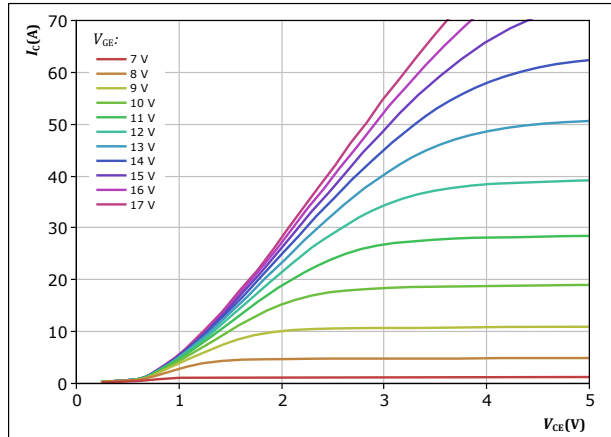
$t_p = 250 \mu s$   
 $V_{GE} = 15 V$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

**figure 2.** IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

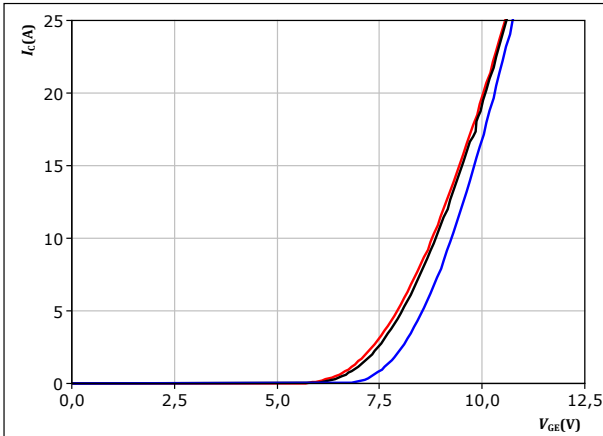


$t_p = 250 \mu s$   
 $T_j = 150 \text{ °C}$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3.** IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



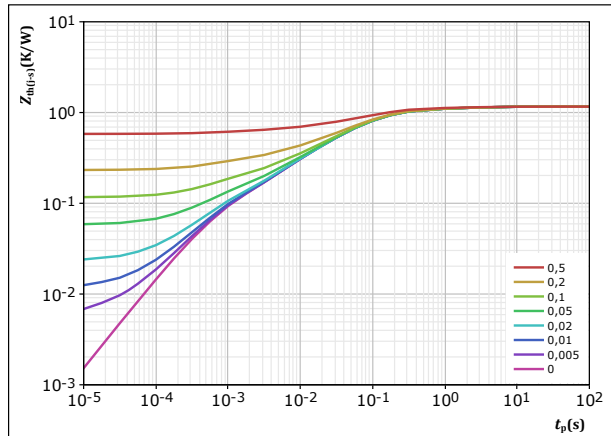
$t_p = 250 \mu s$   
 $V_{CE} = 10 V$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

**figure 4.** IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 1,162 \text{ K/W}$

IGBT thermal model values

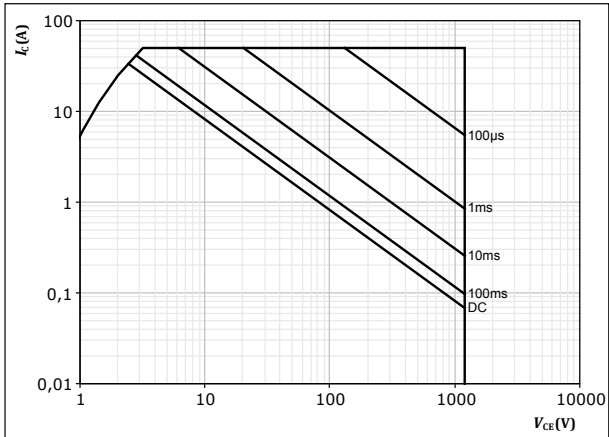
$R$ (K/W)	$\tau$ (s)
5,33E-02	3,54E+00
1,07E-01	5,75E-01
5,05E-01	1,04E-01
2,68E-01	3,30E-02
1,51E-01	7,35E-03
7,80E-02	6,52E-04



## Inverter Switch Characteristics

**figure 5.** IGBT

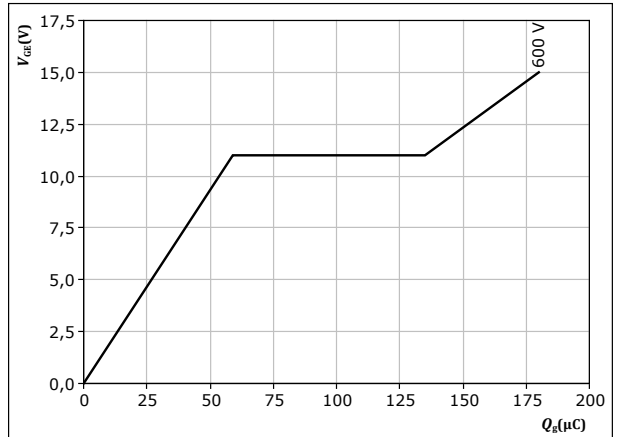
Safe operating area  
 $I_C = f(V_{CE})$



$D =$  single pulse  
 $T_s = 80 \text{ } ^\circ\text{C}$   
 $V_{GE} = 15 \text{ V}$   
 $T_j = T_{jmax}$

**figure 6.** IGBT

Gate voltage vs gate charge  
 $V_{GE} = f(Q_g)$



$I_C = 25 \text{ A}$   
 $T_j = 25 \text{ } ^\circ\text{C}$





### Inverter Diode Characteristics

figure 7. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

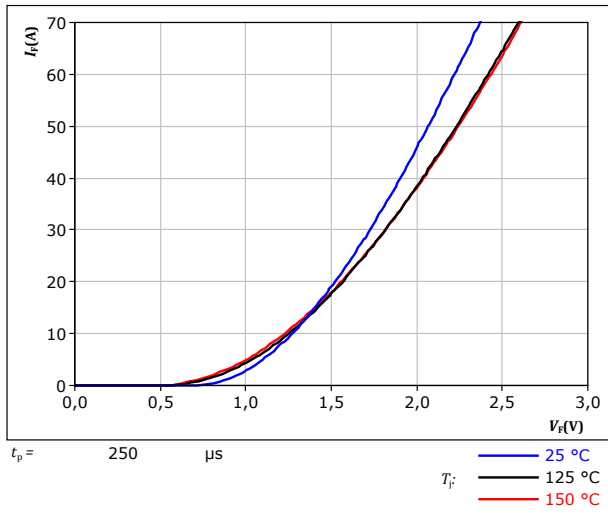
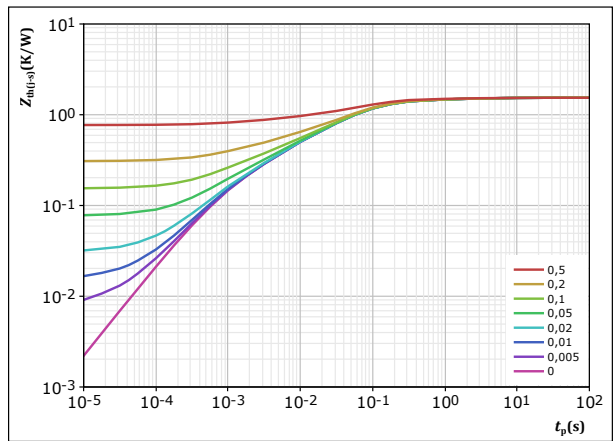


figure 8. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 1,539 \text{ K/W}$   
 FWD thermal model values

$R$ (K/W)	$\tau$ (s)
4,69E-02	5,05E+00
1,06E-01	7,09E-01
5,57E-01	1,01E-01
4,68E-01	3,22E-02
2,35E-01	5,52E-03
8,77E-02	1,01E-03
4,01E-02	5,52E-04



## Rectifier Diode Characteristics

figure 9. Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$

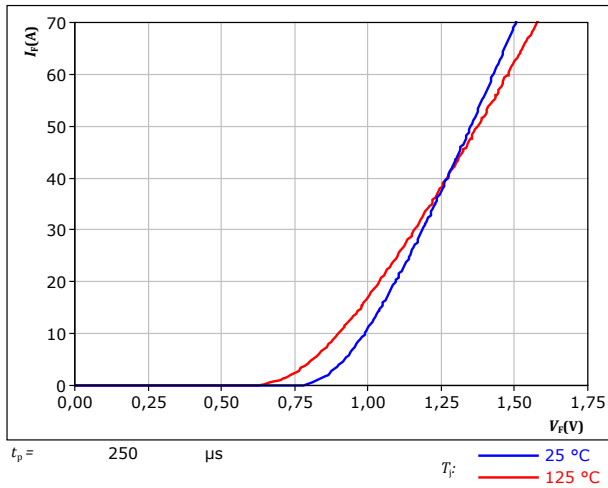
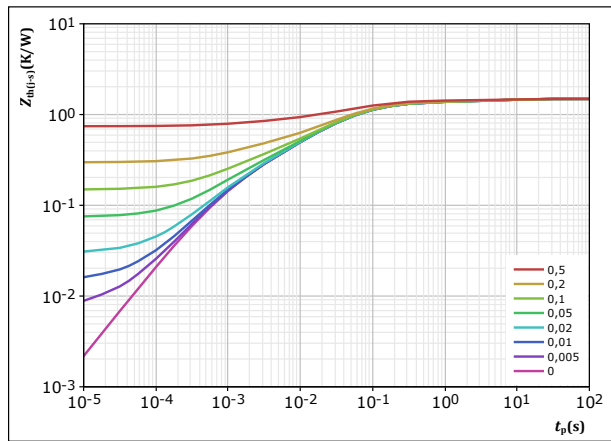


figure 10. Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = \frac{t_p}{T}$   
 $R_{th(j-s)} = 1,487$  K/W  
 Rectifier thermal model values

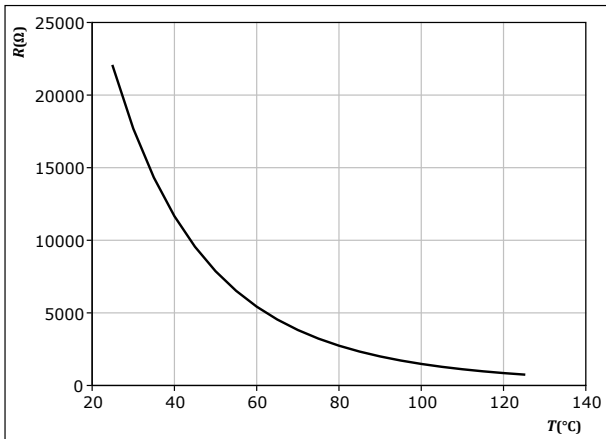
$R$ (K/W)	$\tau$ (s)
1,10E-01	7,06E+00
1,38E-01	3,93E-01
6,16E-01	6,84E-02
3,90E-01	1,63E-02
1,63E-01	2,51E-03
7,11E-02	5,88E-04



### Thermistor Characteristics

figure 11. Thermistor

Typical NTC characteristic as function of temperature  
 $R_T = f(T)$

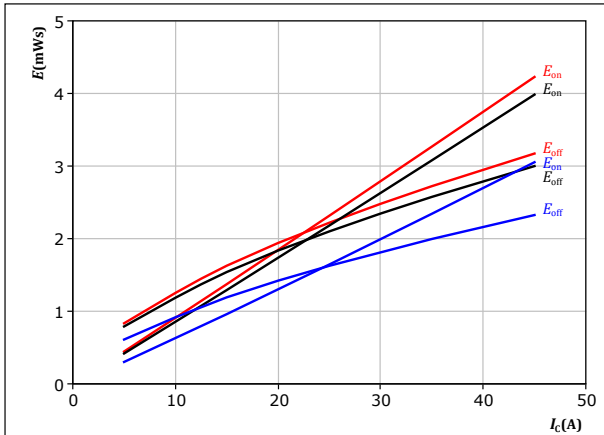




## Inverter Switching Characteristics

**figure 12.** IGBT

Typical switching energy losses as a function of collector current  
 $E = f(I_c)$

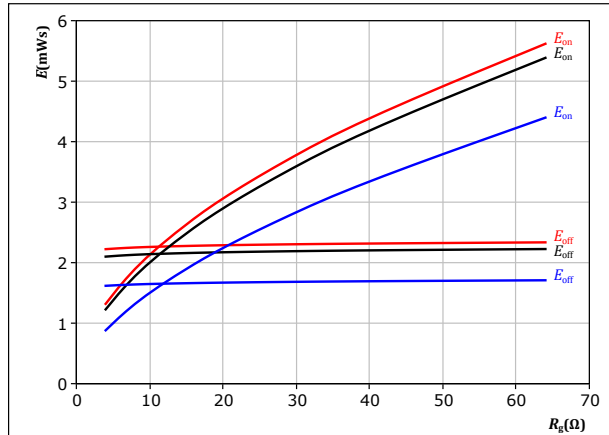


With an inductive load at

$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{gon} =$	8	Ω		150 °C
$R_{goff} =$	8	Ω		

**figure 13.** IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor  
 $E = f(R_g)$

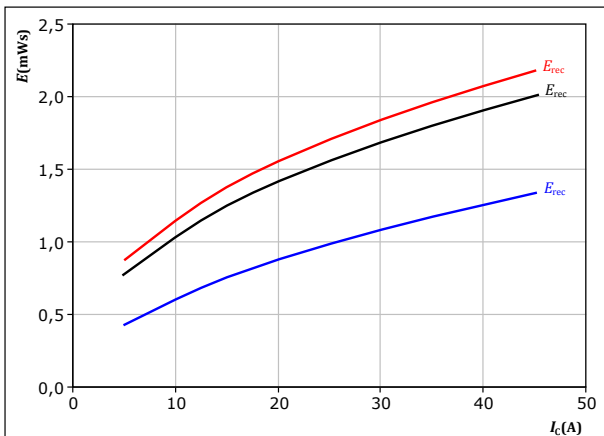


With an inductive load at

$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_c =$	25	A		150 °C

**figure 14.** FWD

Typical reverse recovered energy loss as a function of collector current  
 $E_{rec} = f(I_c)$

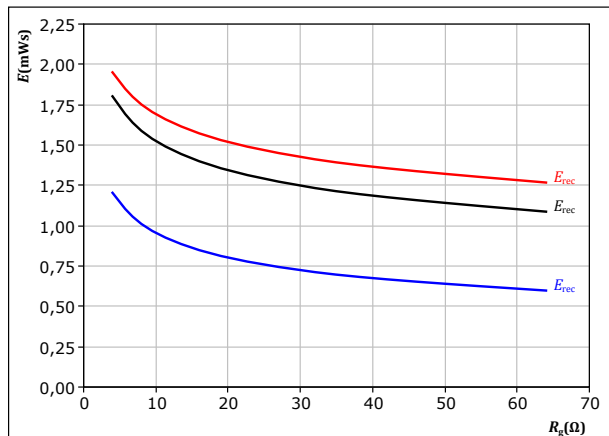


With an inductive load at

$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{gon} =$	8	Ω		150 °C

**figure 15.** FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at

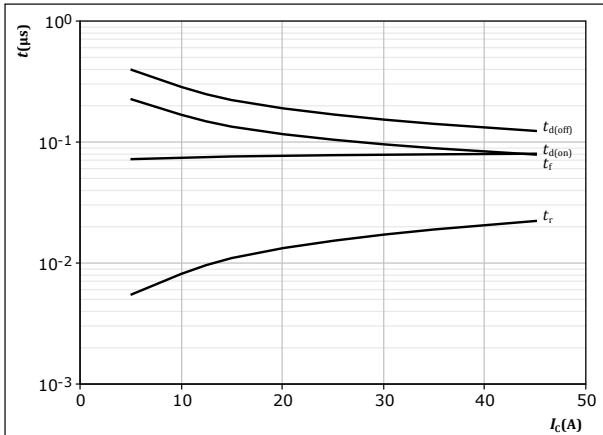
$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_c =$	25	A		150 °C



## Inverter Switching Characteristics

**figure 16.** IGBT

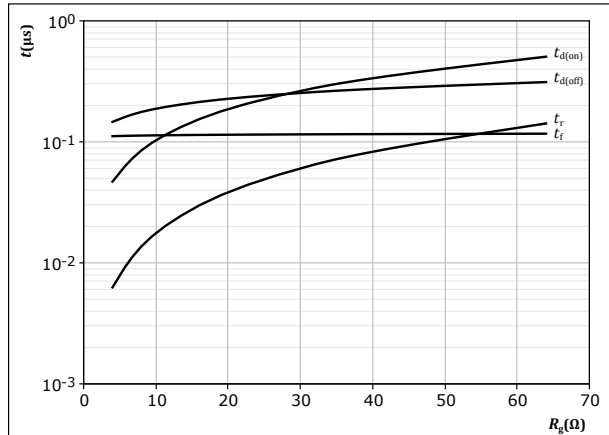
Typical switching times as a function of collector current  
 $t = f(I_c)$



With an inductive load at  
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 8 \text{ } \Omega$   
 $R_{goff} = 8 \text{ } \Omega$

**figure 17.** IGBT

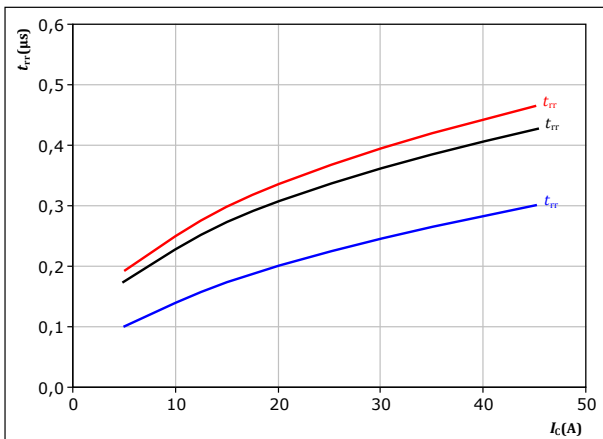
Typical switching times as a function of IGBT turn on gate resistor  
 $t = f(R_g)$



With an inductive load at  
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_c = 25 \text{ A}$

**figure 18.** FWD

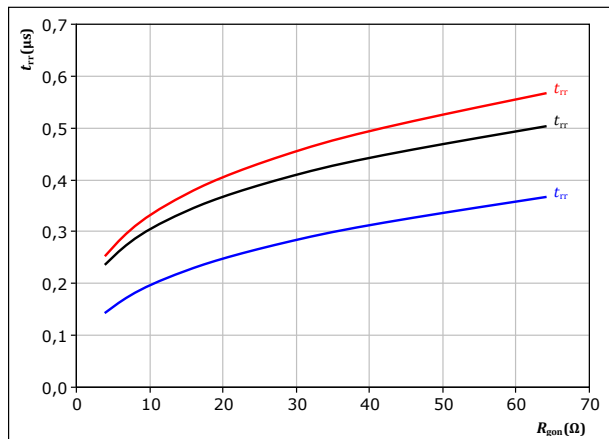
Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_c)$



With an inductive load at  
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 8 \text{ } \Omega$   
 $T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 19.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at  
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_c = 25 \text{ A}$   
 $T_j:$  — 25 °C  
— 125 °C  
— 150 °C

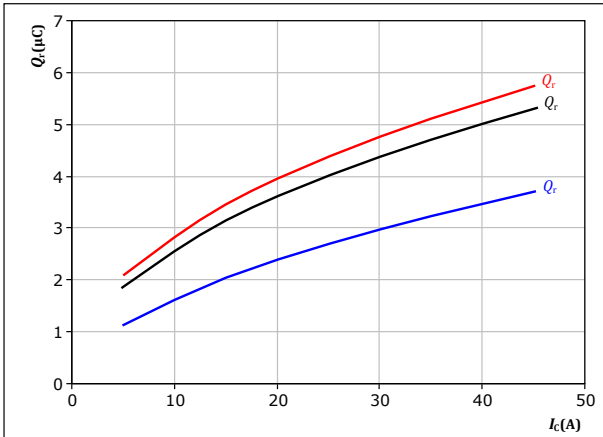


## Inverter Switching Characteristics

**figure 20.** FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



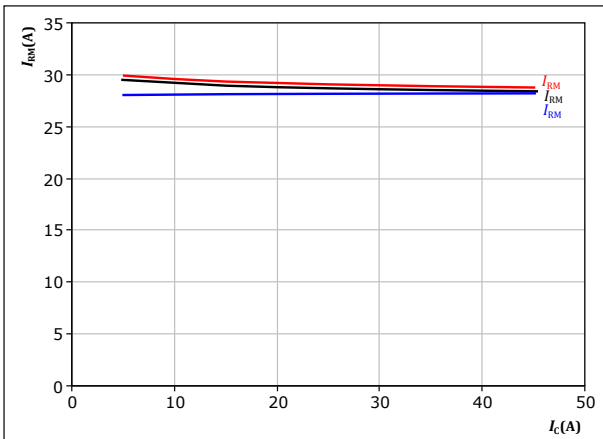
With an inductive load at

$V_{CE} =$	600	V	$T_j:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$R_{gon} =$	8	Ω		—	150 °C

**figure 22.** FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



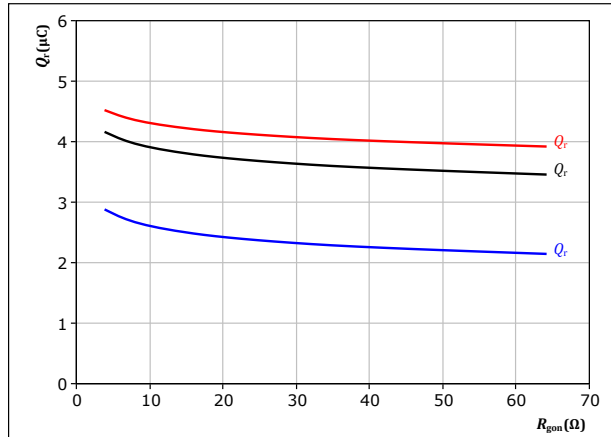
With an inductive load at

$V_{CE} =$	600	V	$T_j:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$R_{gon} =$	8	Ω		—	150 °C

**figure 21.** FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



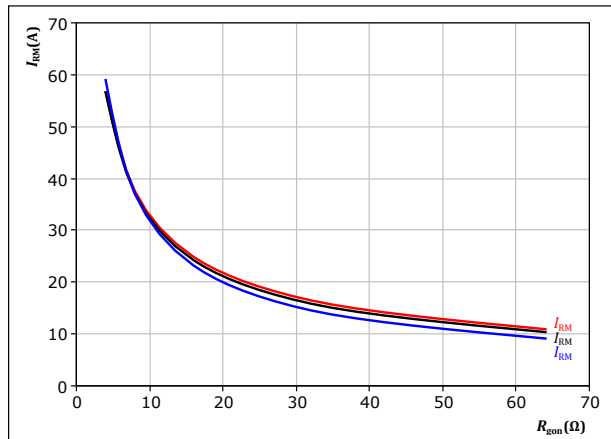
With an inductive load at

$V_{CE} =$	600	V	$T_j:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$I_c =$	25	A		—	150 °C

**figure 23.** FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

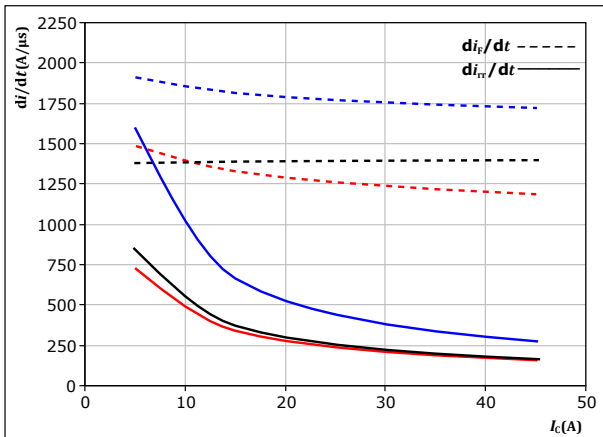
$V_{CE} =$	600	V	$T_j:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$I_c =$	25	A		—	150 °C



## Inverter Switching Characteristics

**figure 24.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_C)$



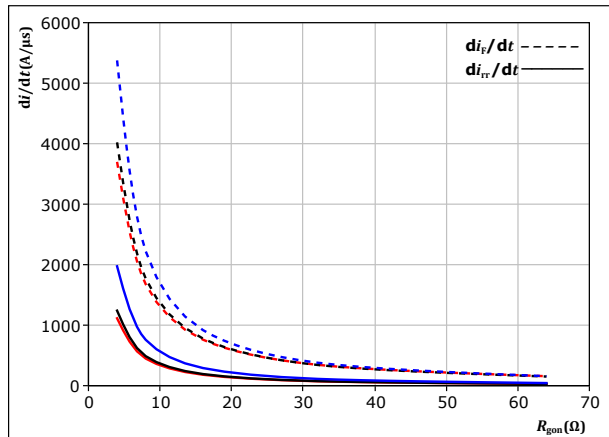
With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 8 \ \Omega$

$T_j = 25 \text{ }^\circ\text{C}$   
 $125 \text{ }^\circ\text{C}$   
 $150 \text{ }^\circ\text{C}$

**figure 25.** FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

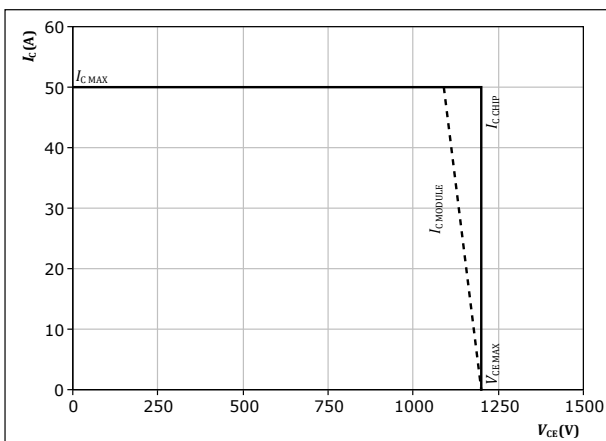
$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 25 \text{ A}$

$T_j = 25 \text{ }^\circ\text{C}$   
 $125 \text{ }^\circ\text{C}$   
 $150 \text{ }^\circ\text{C}$

**figure 26.** IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$

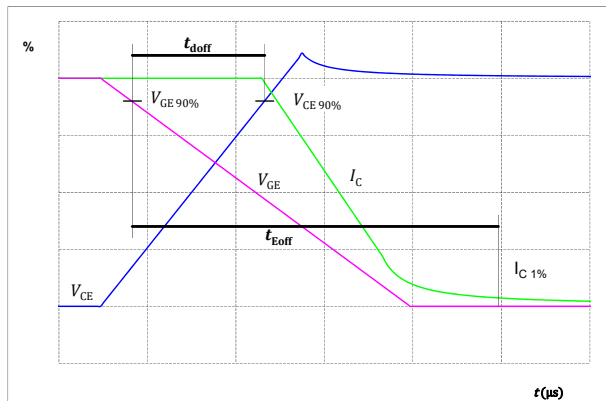


At  $T_j = 150 \text{ }^\circ\text{C}$   
 $R_{gon} = 8 \ \Omega$   
 $R_{goff} = 8 \ \Omega$

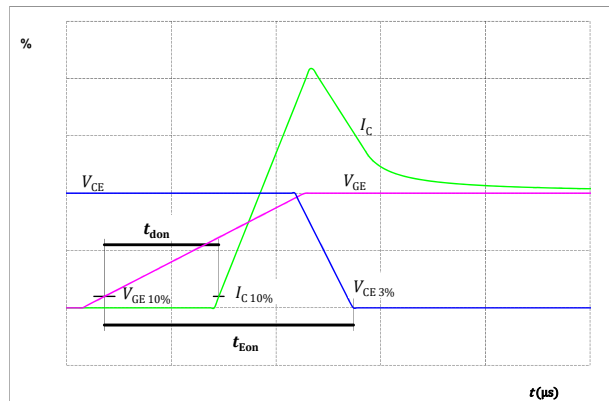


### Inverter Switching Definitions

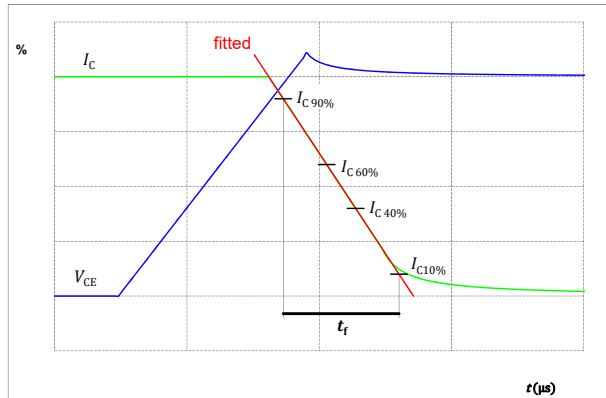
**figure 27.** IGBT  
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



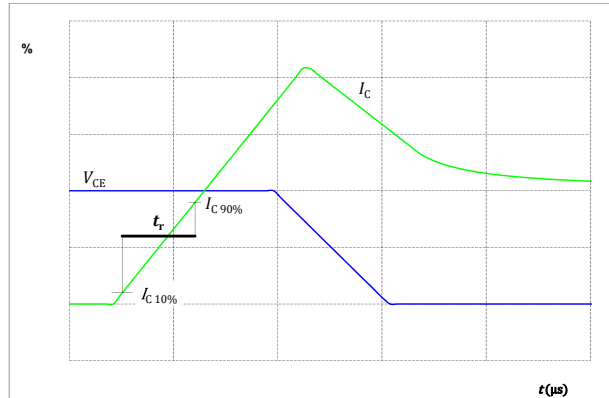
**figure 28.** IGBT  
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



**figure 29.** IGBT  
Turn-off Switching Waveforms & definition of  $t_f$



**figure 30.** IGBT  
Turn-on Switching Waveforms & definition of  $t_r$







### Inverter Switching Definitions

figure 31. FWD

Turn-off Switching Waveforms & definition of  $t_{rr}$

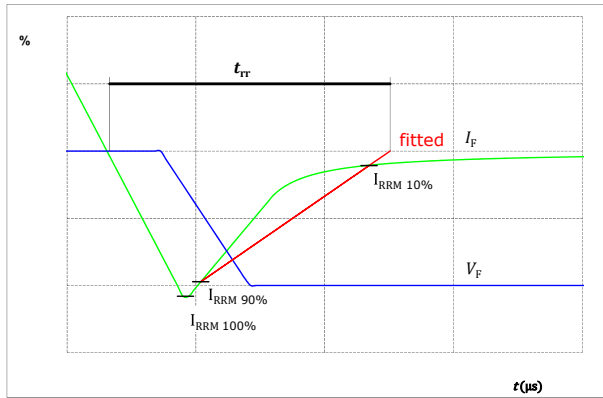
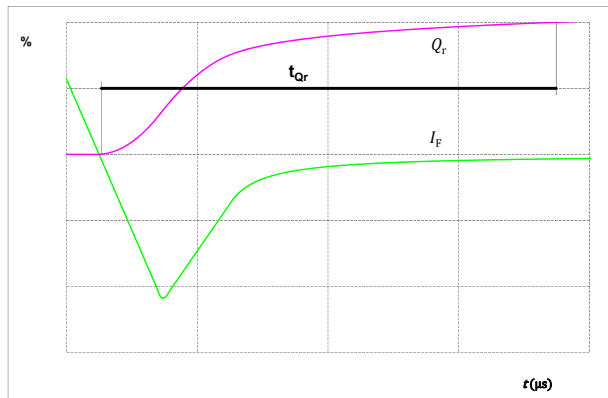


figure 32. FWD

Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr}$  = integrating time for  $Q_r$ )






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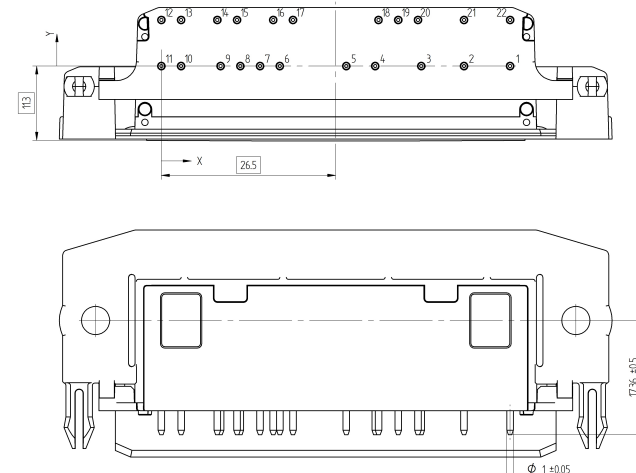
**10-R112PNA025M7-P630C70**  
datasheet

Ordering Code	
<b>Version</b>	<b>Ordering Code</b>
Without thermal paste	10-R112PNA025M7-P630C70
With thermal paste (3,4 W/mK, PSX-P7)	10-R112PNA025M7-P630C70-/3/

Marking						
	<b>Text</b>	<b>Name</b> NN-NNNNNNNNNNNNNN- TTTTTVV	<b>Date code</b> WWYY	<b>UL &amp; VIN</b> UL VIN	<b>Lot</b> LLLLL	<b>Serial</b> SSSS
	<b>Datamatrix</b>	<b>Type&amp;Ver</b> TTTTTTVV	<b>Lot number</b> LLLLL	<b>Serial</b> SSSS	<b>Date code</b> WWYY	

Pin table [mm]			
Pin	X	Y	Function
1	53	0	L2
2	46	0	BrC
3	39,5	0	DC-
4	32,5	0	DC+
5	28,1	0	Inv+
6	18	0	WLG
7	15	0	WL
8	12	0	VLG
9	9	0	VL
10	3	0	ULG
11	0	0	UL
12	0	7	UHG
13	3	7	U
14	8,5	7	VHG
15	11,5	7	V
16	17	7	WHG
17	20	7	W
18	33	7	NTC
19	36	7	BrE
20	39	7	BrG
21	46	7	L3
22	53	7	L1

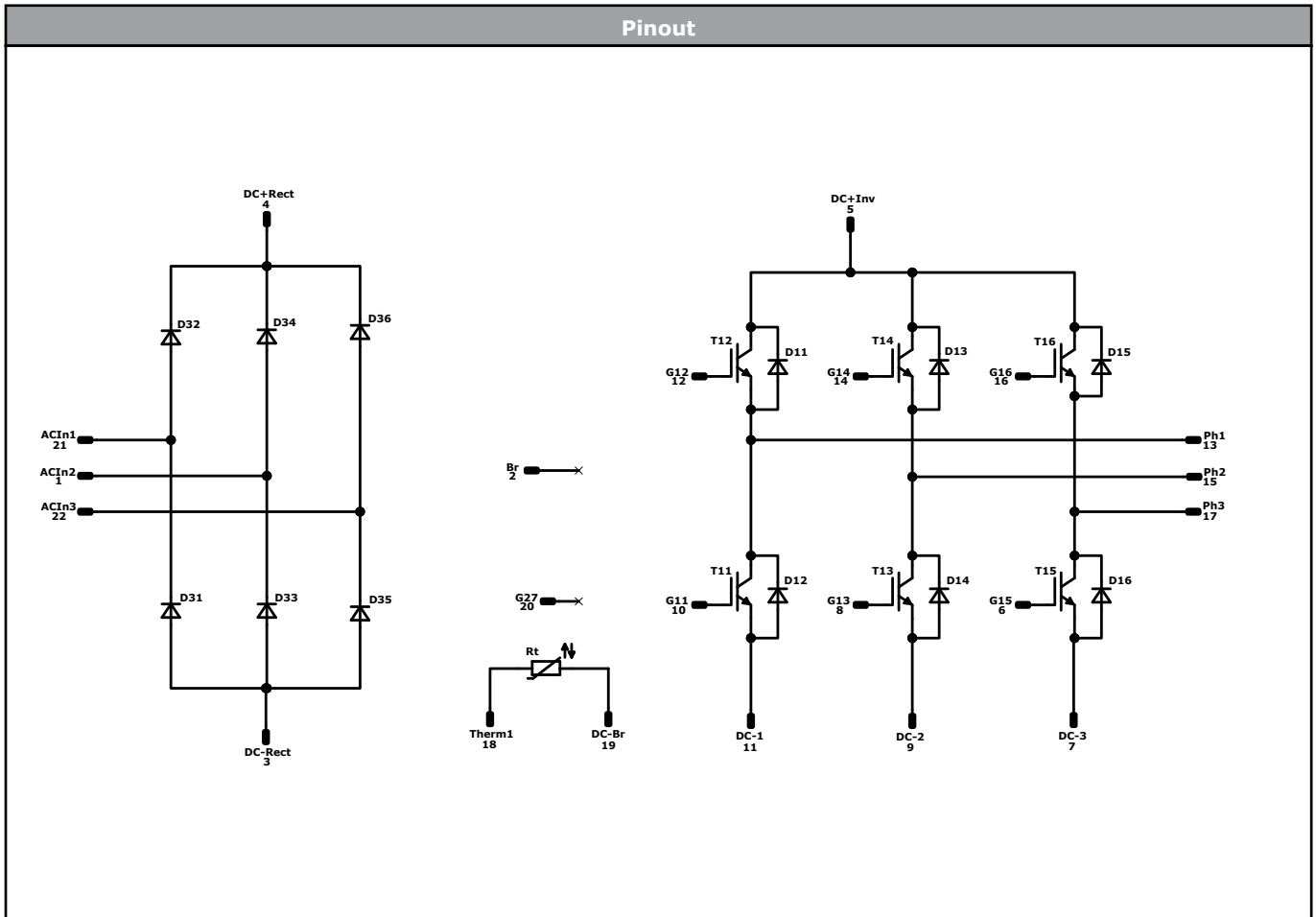
**Outline**



Tolerance of pinpositions: ±0.5mm at the end of pins  
Dimension of coordinate axis is only offset without tolerance



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Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	1200 V	25 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	1200 V	25 A	Inverter Diode	
D31, D32, D33, D34, D35, D36	Rectifier	1600 V	25 A	Rectifier Diode	
Rt	Thermistor			Thermistor	




Packaging instruction				
Standard packaging quantity (SPQ) 80	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow90</i> 1 packages see vincotech.com website.

Package data
Package data for <i>flow90</i> 1 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-R112PNA025M7-P630C70-D2-14	14 Nov. 2022	Change of Thermistor	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.